VIN = 24V DC (±10%)
POSITIVE LV-Mid PUSH-PULL POWER SUPPLY

fsw = 200kHz  tss ~ 1 sec

Non-ftr input of the op-amp is 0.00001 (=10k/110k) times the VOUT-P2

Engineer: Sanjay Pithadia
Drawn By: [Drawn By]

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NEGATIVE LV-Mid PUSH-PULL POWER SUPPLY

Output of this stage is 0.09091 \(-=10k/110k\) times the VOUT-N2

fsw = 200kHz  \(t_{ss} \sim 1\) sec
PCB Number: TIDA-01352
PCB Rev: E2

Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
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<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Notes

ZZ8
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ9
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ10
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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